

TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

ETAS ID: TM481709

SUBMISSION TYPE:	NEW ASSIGNMENT		
NATURE OF CONVEYANCE:	RELEASE OF SECURITY INTEREST		
CONVEYING PARTY DATA			
Name	Formerly	Execution Date	Entity Type
SJC DLF II-D, LLC		06/18/2018	Limited Liability Company: DELAWARE
RECEIVING PARTY DATA			
Name:	LLFlex, LLC, individually, and as successor by merger with Oracle Flexible Packaging, Inc.		
Street Address:	1225 West Burnett Avenue		
City:	Louisville		
State/Country:	KENTUCKY		
Postal Code:	40210		
Entity Type:	Limited Liability Company: ILLINOIS		
PROPERTY NUMBERS Total: 5			
Property Type	Number	Word Mark	
Registration Number:	2157658	REYSHIELD	
Registration Number:	4010464	REYFLEX	
Registration Number:	1322147	ORACLE	
Registration Number:	4143258	NANOLID	
Registration Number:	4143259	NANOPOUCH	
CORRESPONDENCE DATA			
Fax Number:	5616596313		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>			
Phone:	561-653-5000		
Email:	angela.martin@akerman.com		
Correspondent Name:	Akerman LLP		
Address Line 1:	777 S. Flagler Dr., Ste 1100 West Tower		
Address Line 4:	West Palm Beach, FLORIDA 33401		
ATTORNEY DOCKET NUMBER:	0335389		
NAME OF SUBMITTER:	Peter A. Chiabotti		
SIGNATURE:	/Peter A. Chiabotti/		
DATE SIGNED:	07/13/2018		

CH \$140.00 2157658

Total Attachments: 10

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Release of Security Interest in Intellectual Property Rights

THIS RELEASE OF SECURITY INTEREST IN INTELLECTUAL PROPERTY RIGHTS (this “**Release**”) is entered into as of June 18, 2018 by and among LLFlex, LLC, an Illinois limited liability company (the “**Assignor**”), individually and as successor by merger with Oracle Flexible Packaging, Inc., a North Carolina corporation (“**Oracle**”), and SJC DLF II-D, LLC, a Delaware limited liability company, as agent (the “**Agent**” or the “**Assignee**”) for the lenders party to that certain Loan Agreement, dated as of February 28, 2014 (as amended by that certain First Amendment to Loan Agreement and Joinder, dated as of February 20, 2015, that certain Second Amendment to Loan Agreement, dated as of April 27, 2016, that certain Third Amendment to Loan Agreement, dated as of April 26, 2017 and that certain Fourth Amendment to Loan Agreement, dated as of May 15, 2018, and as the same has been and may hereafter be amended, amended and restated, modified, supplemented, extended, renewed or replaced, the “**Loan Agreement**”), by and among LLFLEX, LLC, an Illinois limited liability company (“**LLFLEX**” or the “**Borrower**”), individually and as successor by merger with Oracle, LLFLEX HOLDINGS, LLC, a Delaware limited liability company (“**Parent**”), CLP LLFLEX HOLDINGS, LLC, a Delaware limited liability company (“**Holdings**” and, together with Parent, collectively, the “**Guarantors**” and each individually as a “**Guarantor**”) SJC DLF II-D, LLC, a Delaware limited liability company (in its individual capacity, “**SJC**”), as agent (in such capacity as agent, including its successors and assigns, “**Agent**”) for itself and all other lenders (the “**Lenders**”) from time to time party to the Loan Agreement. Capitalized terms used but not defined herein shall have the respective meanings given thereto in the Loan Agreement;

WHEREAS, reference is made to that certain Intellectual Property Security Agreement, dated as of February 28, 2016 (as amended, restated, amended and restated, supplemented or otherwise modified immediately prior to the date hereof, the “**LLFlex IP Security Agreement**”), which granted to the Assignee for the benefit of the Secured Parties a continuing security interest in all of the right, title and interest of the Assignor (or the relevant predecessor in interest, as applicable) in and to the Trademarks, Patents, Copyrights, Licenses and Domain Names (each as defined in the LLFlex IP Security Agreement, and collectively, the “**LLFlex IP**”), including, without limitation, each Patent registration and application referred to in Schedule A hereto, each Trademark registration and application referred to in Schedule B hereto and each Domain Name referred to in Schedule C hereto;

WHEREAS, reference is made to that certain Intellectual Property Security Agreement, dated as of February 28, 2016 (as amended, restated, amended and restated, supplemented or otherwise modified immediately prior to the date hereof, the “**Oracle IP Security Agreement**” and, together with the LLFlex IP Security Agreement, the “**IP Security Agreements**”), which granted to the Assignee for the benefit of the Secured Parties a continuing security interest in all of the right, title and interest of Oracle (or the relevant predecessor in interest, as applicable) in and to the Trademarks, Patents, Copyrights, Licenses and Domain Names (each as defined in the Oracle IP Security Agreement, and collectively, the “**Oracle IP**” and, together with the LLFlex IP, the

“IP”), including, without limitation, each Patent registration and application referred to in Schedule D hereto, each Trademark registration and application referred to in Schedule E hereto and each Domain Name referred to in Schedule F hereto;

WHEREAS, on or about June 13, 2018, Oracle merged Assignor and Assignor is the successor-in-interest to Oracle and the Oracle IP;

WHEREAS, pursuant to the terms and conditions of the Loan Agreement and IP Security Agreements, the Assignor (or the relevant predecessor in interest, as applicable) granted to the Assignee a continuing security interest in and lien on all of their right, title and interest in and to the IP;

WHEREAS, the LIFlex IP Security Agreement was recorded with the United States Patent and Trademark Office (the “USPTO”) on reel 032378 frame 0709 and on reel 5228 frame 0001;

WHEREAS, the Oracle IP Security Agreement was recorded with the USPTO on reel 032378 frame 0624 and reel 5227 frame 0975;

WHEREAS, the Agent has agreed to terminate and release its security interest in and lien on the IP.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, the parties hereto agree as follows:

Section 1. *Release of Security Interest in the Intellectual Property.* (a) The Agent hereby terminates the IP Security Agreement and hereby cancels, re-pledges, reassigns and releases any and all security interests it has against the IP.

(b) If and to the extent the Agent has acquired any right, title or interest in, to or under any of the IP, the Agent hereby assigns, transfers, conveys and delivers such right, title or interest to the Assignor.

(c) The Agent hereby agrees, at the expense of the Assignor, to execute and deliver to the Assignor such additional documents, instruments and certificates, and take such other actions, as the Assignor shall reasonably request to evidence the termination of the Agent’s lien on, and the release of, the IP.

Section 2. *Recordation of Release.* The Agent hereby authorizes and requests that the Commissioner for Patents in the USPTO, and any other necessary United States government officer, record this Release; it being understood that such recordation shall be at the Assignor’s sole expense.

Section 3. *Counterparts.* This Release may be executed in any number of counterparts, each of which when so executed shall be deemed to be an original and all of which when taken together shall constitute one and the same agreement.

Section 4. *Governing Law.* This Release shall be governed by and construed in accordance with the laws of the State of New York.

[Remainder of page intentionally left blank.]

IN WITNESS WHEREOF, the Agent has caused this Release to be executed by its duly authorized representative:

SJC DLF II-D, LLC,
as Agent

By: 

Name: Stephen J. Czech

Title: Executive Officer

SCHEDULE A

LLFLEX UNITED STATES PATENTS AND DESIGN PATENT

Title	Issue Date	Country	Application/Registration No.
Multi-layered Water Blocking Cable Armor Laminate Containing Water Swelling Fabrics and Method of Making Such	4/21/2009	U.S.	7,522,794
Multi-layered Water Blocking Cable Armor Laminate Containing Water Swelling Fabrics and Associated Methods of Manufacture	6/30/2009	U.S.	7,555,182
Aluminum Alloys for Armored Cables	5/19/2009	U.S.	7,536,072

SCHEDULE B

**LLFLEX UNITED STATES TRADEMARKS AND TRADEMARK
APPLICATIONS**

Title	Filing Date/Issue Date	Country	Sernial No./Registration No.
Reyshield®	October 23, 1996	U.S.	2,157,658
Reyflex®	August 23, 2010	U.S.	4,010,464

SCHEDULE C

LLFLEX DOMAIN NAMES

WWW.LLFLEX.COM
WWW.LLFLEX.INFO
WWW.LLFLEX.NET
WWW.LLFLEX.US
WWW.LOUISVILLELAMINATING.COM

SCHEDULE D

ORACLE UNITED STATES PATENTS AND DESIGN PATENT

Title	Filing Date/Issue Date	Country	Application No.	Patent No.
Thin film structures for and method of sealing to glass	7/2/2002	U.S.	08813961	6413644
Gravure printing press with encapsulated ink applicator and method	9/19/2000	U.S.	08944168	6119595
Polymeric die-cuttable lidding materials	8/30/1994	U.S.	08065726	5342684
Peelable film laminate	11/15/1988	U.S.	06902340	4784885

SCHEDULE E

ORACLE UNITED STATES TRADEMARKS AND TRADEMARK APPLICATIONS

Mark	Filing Date/Issue Date	Country	Application/Registration No.
ORACLE	May 25, 1984	U.S.	1322147
NANOLID	May 5, 2010	U.S.	4143258
NANOPOUCH	May 5, 2010	U.S.	4143259

SCHEDULE F
ORACLE DOMAIN NAMES

WWW.ORACLEPACKAGING.COM